

3.0x2.0mm SURFACE MOUNT LED LAMP

Part Number: AA3021CGSK Green

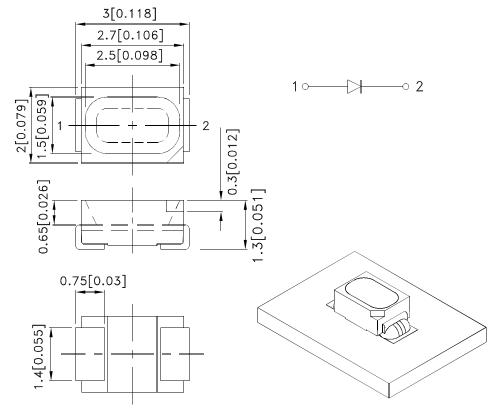
Features

- 3.0mm x 2.0mm, 1.3mm high, only minimum space required.
- Suitable for compact optoelectronic applications.
- Low power consumption.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

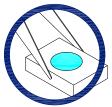
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Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

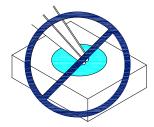
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

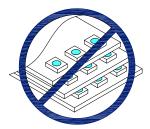


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

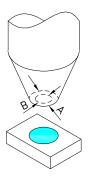




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



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Selection Guide

| Part No. | Dice | Lens Type | Iv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|---------------------------|------|----------------|------------------------|------|----------------------|
| | | 2. | Min. | Тур. | 201/2 |
| A3021CGSK Green (AlGaInP) | | Water Clear 40 | | 80 | 125° |

- Notes: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|--------|------|------|-------|-----------------|
| λpeak | Peak Wavelength | Green | 574 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Green | 570 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Green | 20 | | nm | IF=20mA |
| С | Capacitance | Green | 15 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Green | 2.1 | 2.5 | V | IF=20mA |
| lr | Reverse Current | Green | | 10 | uA | VR=5V |

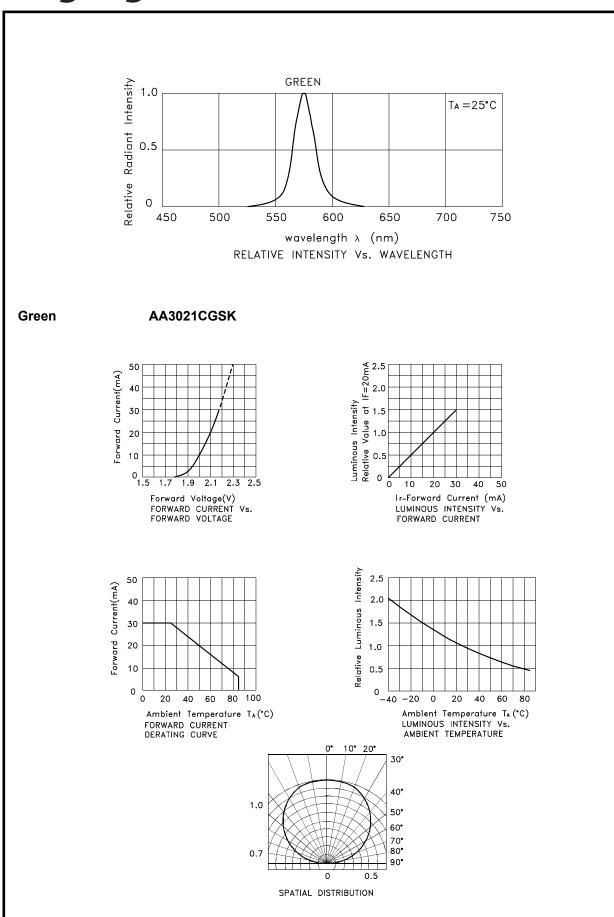
- Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

| Autobiato maximum raumgo at 171 20 0 | | | | | |
|--------------------------------------|--|--|--|--|--|
| Green | | | | | |
| 75 | mW | | | | |
| 30 | mA | | | | |
| 150 | mA | | | | |
| 5 | V | | | | |
| -40°C To +85°C | | | | | |
| -40°C To +85°C | | | | | |
| | 75 30 150 5 -40°C To +85°C | | | | |

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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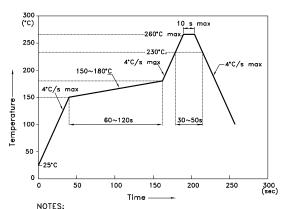


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AA3021CGSK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



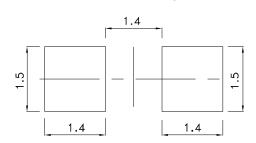
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

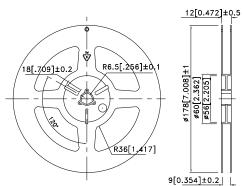
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - to high temperature.

 3.Number of reflow process shall be 2 times or less.

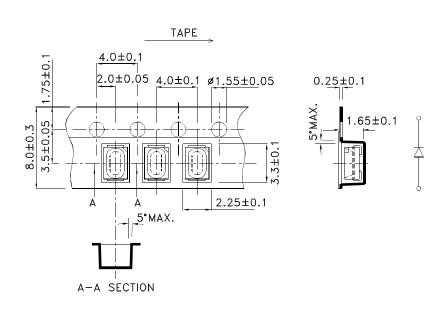
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension

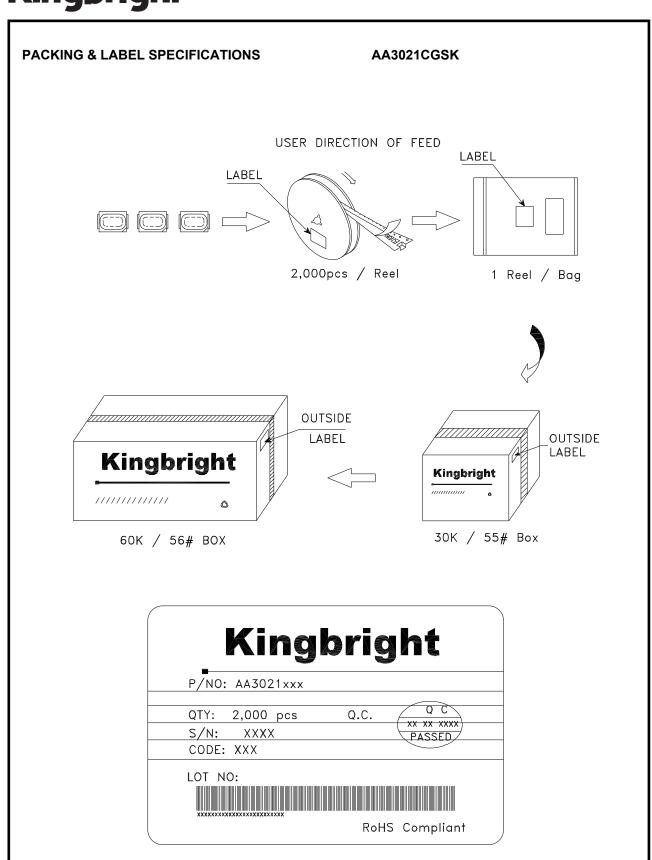


Tape Dimensions (Units : mm)



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